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#### April 2015

FDB110N15A — N-Channel PowerTrench<sup>®</sup> MOSFET

## FDB110N15A N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 92 A, 11 m $\Omega$

#### Features

- $R_{DS(on)}$  = 9.25 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 92 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

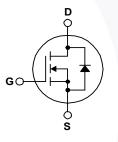
### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

#### Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter	FDB110N15A	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	rain to Source Voltage			V	
V <sub>GSS</sub>	Cata to Source Valtage	- DC	- DC		V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	v	
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		92	^	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)	1.	65	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	369	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		365	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6	V/ns		
P <sub>D</sub>	Power Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		234	W	
	Power Dissipation	- Derate Above 25°C		1.56	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

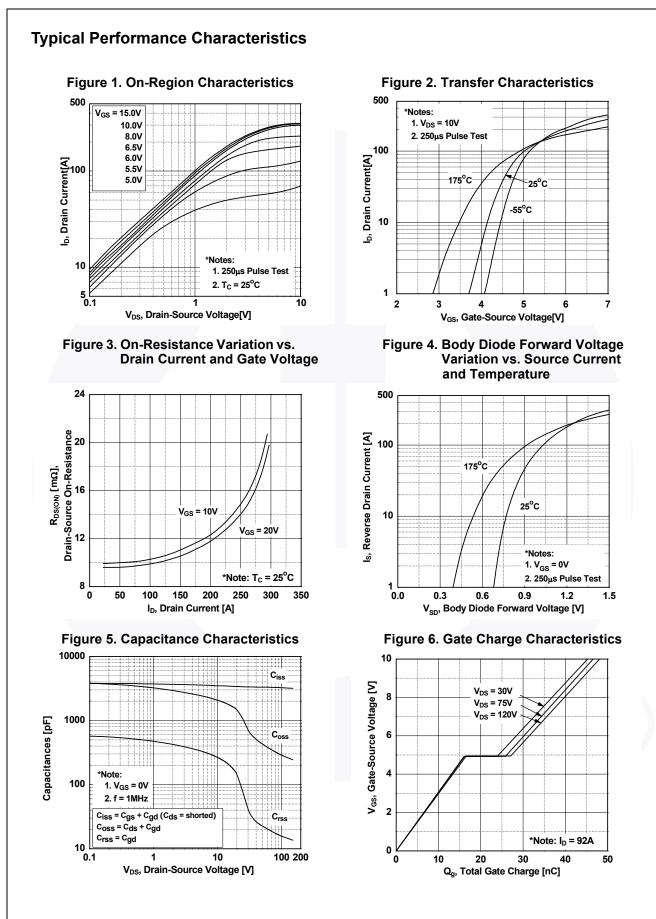
## **Thermal Characteristics**

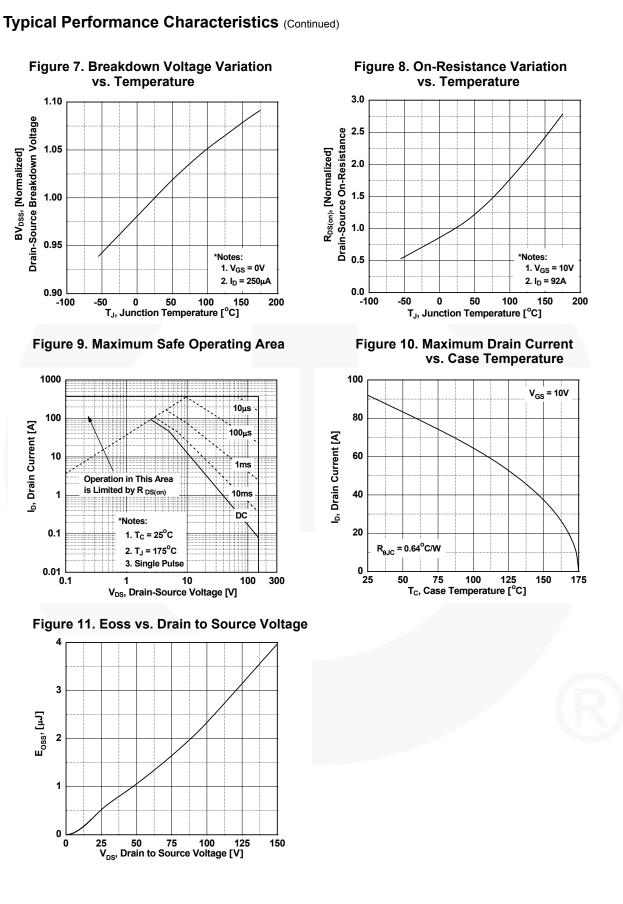
Symbol	Parameter	FDB110N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.64	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	0/00

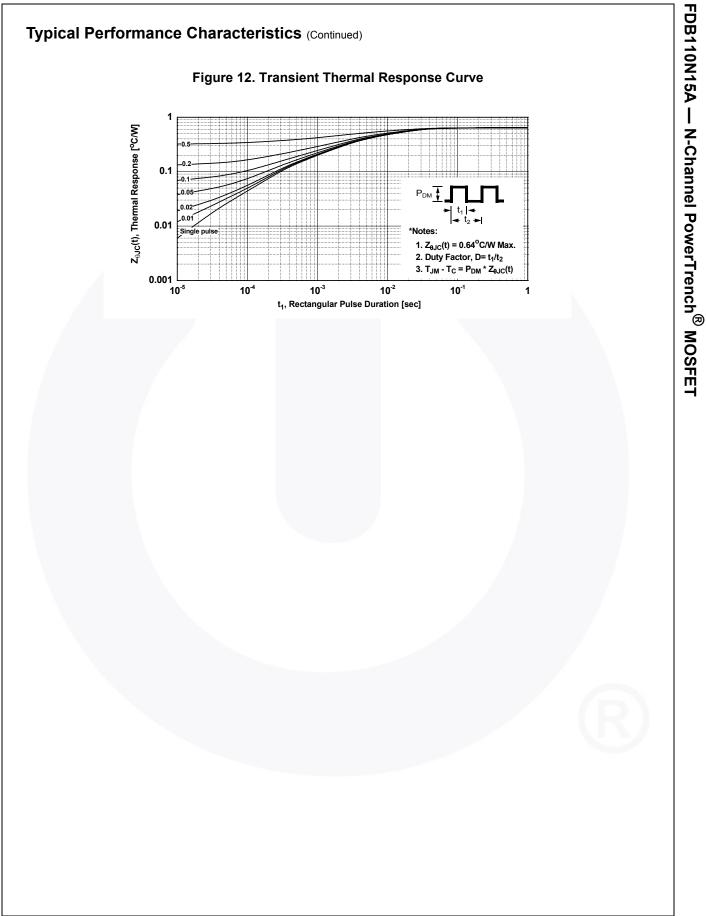
Part Nun	nber	Top Mark	Package	Packing Metho	d Reel Size	Тар	e Width	Qua	ntity
		FDB110N15A	D <sup>2</sup> -PAK	Tape and Reel 330 mm		24 mm		800 units	
Electrica	I Char	acteristics T <sub>C</sub> = 2	5°C unless o	therwise noted.					
Symbol		Parameter		Test Cond	litions	Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage			I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V			-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>		own Voltage Temperature		$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-	0.09	-	V/ºC
1				V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V		-	-	1	
DSS	Zero Ga	te Voltage Drain Curren		V <sub>DS</sub> = 120 V, T <sub>C</sub> = 1	50°C	-	-	500 μA	μΑ
I <sub>GSS</sub>	Gate to	Body Leakage Current	,	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charac	teristics	6							
V <sub>GS(th)</sub>	Gate Th	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250$	μA	2.0	-	4.0	V
R <sub>DS(on)</sub>		rain to Source On Resist		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 92$		-	9.25	11.0	mΩ
9FS	Forward	I Transconductance		$V_{\rm DS}$ = 10 V, I <sub>D</sub> = 92		-	118	-	S
Dynamic C	haracte	eristics							
C <sub>iss</sub>	Input Ca	apacitance		V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	3390	4510	pF
C <sub>oss</sub>	Output 0	Capacitance				-	334	445	pF
C <sub>rss</sub>	Reverse	Transfer Capacitance				-	14	-	pF
C <sub>oss</sub> (er)	Engry R	eleted Output Capacitan	се	V <sub>DS</sub> = 75 V, I <sub>D</sub> = 92	A	-	583	-	pF
Q <sub>g(tot)</sub>	Total Ga	te Charge at 10V				-	47	61	nC
Q <sub>gs</sub>	Gate to	Source Gate Charge		V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 75 V, I <sub>D</sub> = 92 A		-	16	-	nC
Q <sub>gs2</sub>	Gate Ch	arge Threshold to Plate	au			-	7.9	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge			(Note 4)	-	9.7	-	nC
Switching	Charact	teristics							
t <sub>d(on)</sub>	-	Delay Time				-	25	60	ns
t <sub>r</sub>		Rise Time		V <sub>DD</sub> = 75 V, I <sub>D</sub> = 92 A,		-	26	62	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4$	7Ω	-	46	102	ns
t <sub>f</sub>	Turn-Off	Fall Time			(Note 4)	-	14	38	ns
ESR	Equivale	ent Series Resistance (G	-S)	f = 1 MHz	(1012-1)	-	2.5	-	Ω
Drain Sou		le Characteristics					1		
s		m Continuous Drain to S	ource Diode	Forward Current			-	92	А
I <sub>SM</sub>		m Pulsed Drain to Sourc				-	-	369	A
V <sub>SD</sub>		Source Diode Forward \		$V_{GS} = 0 V, I_{SD} = 92$	Α	-	-	1.25	V
t <sub>rr</sub>		Recovery Time	0	$V_{GS} = 0.V, I_{SD} = 92.A$ $V_{GS} = 0.V, I_{SD} = 92.A, V_{DD} = 75.V,$ $dI_F/dt = 100.A/\mu s$		-	89	-	ns
Q <sub>rr</sub>		Recovery Charge				-	255	-	nC
Notes: 1. Repetitive rating 2. L = 3 mH, $I_{AS}$ = 3. $I_{SD} \le 92$ A, di/dt	: pulse width- 15.6 A, R <sub>G</sub> = ≤ 200 A/µs, V	limited by maximum junction terr 25 $\Omega$ , starting T <sub>J</sub> = 25°C. $t_{DD} \leq BV_{DSS}$ , starting T <sub>J</sub> = 25°C. erating temperature typical characteristics	perature.				200	Œ	

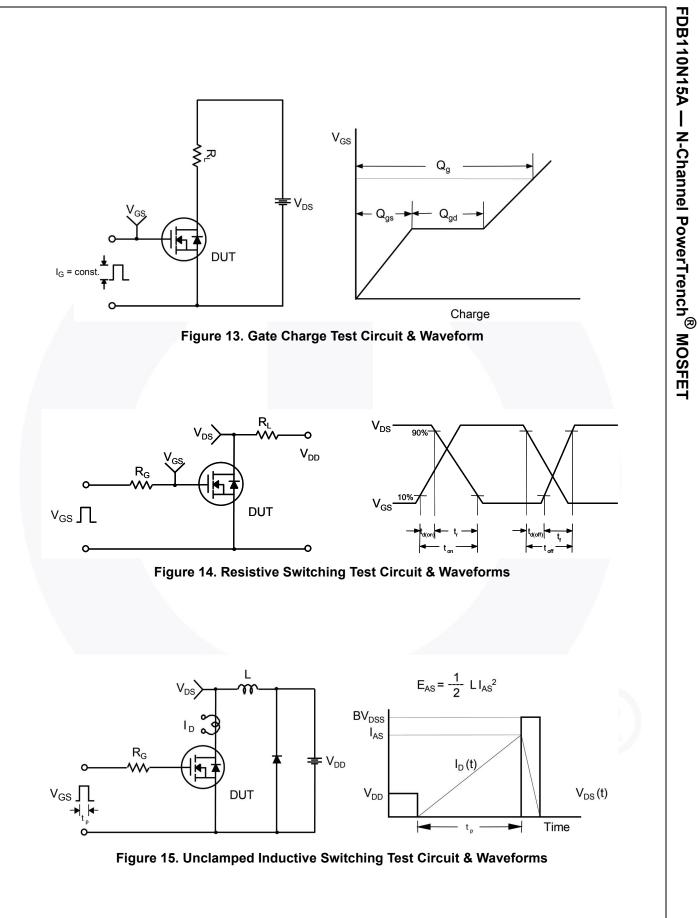
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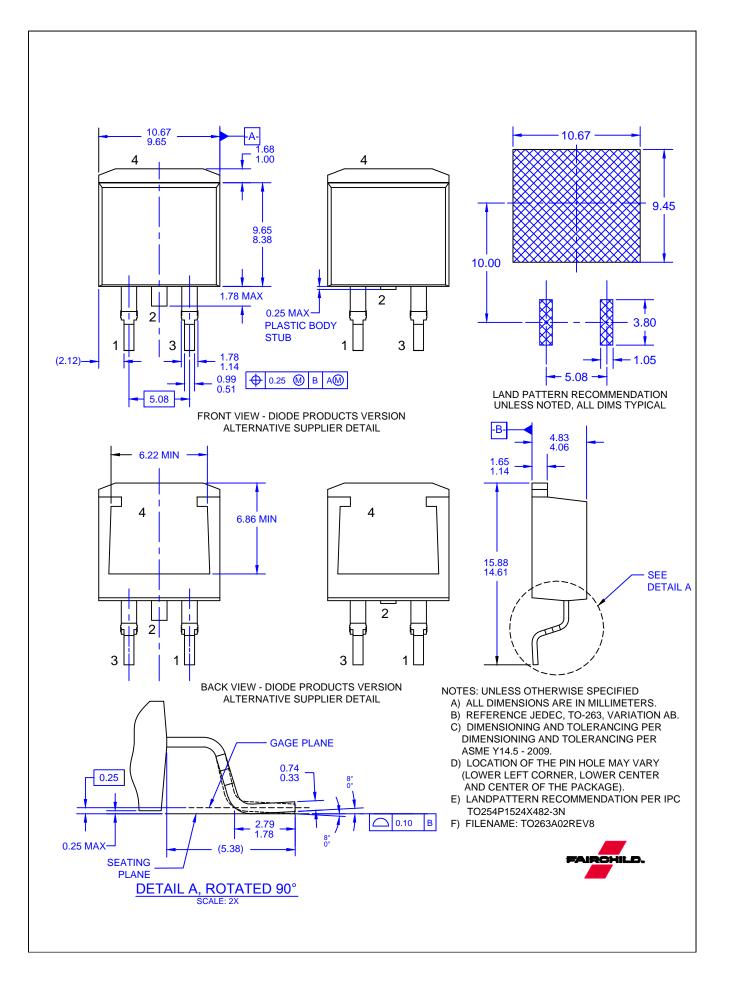






DUT +  $v_{DS}$ a ۱<sub>SD</sub> م L Driver R<sub>G</sub>, Same Type as DUT L F V<sub>DD</sub>  $\prod V_{GS}$ • dv/dt controlled by R<sub>G</sub> • I<sub>SD</sub> controlled by pulse period Î Gate Pulse Width V<sub>GS</sub> D = Gate Pulse Period 10V (Driver) I<sub>FM</sub>, Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current  $V_{DS}$ (DUT) Body Diode Recovery dv/dt  $V_{SD}$ V<sub>DD</sub> Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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